

RX220 Group and RX21A Group

R01AN1884EJ0100

Rev.1.00

Asynchronous SCI Communication Using the DTCa

Feb 14, 2014

Introduction

This application note describes methods for performing asynchronous serial communication using the data transfer controller (DTC) and serial communications interface (SCI) peripheral modules provided by the RX220 Group and RX21A Group microcontrollers.

Target Device

- RX220 Group: 100-pin versions with ROM capacities of 32 to 256 KB
- RX21A Group: 100-pin versions with ROM capacities of 256 to 512 KB

When using the code presented in this application note with a different microcontroller, modify the code according to the specifications of that microcontroller and test the code thoroughly.

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1. Specifications

This system performs serial communication using the SCI.

The transmit data is set up in advance in the RAM transmit data storage area and transmitted using the DTC. The receive data is stored in the RAM receive data storage area using the DTC.

Serial communication is started when a falling edge is detected on the interrupt request pin (IRQ1).

- Transfer rate : 38,400 bps
- Data length : 8 bits, LSB first
- Stop bits : 1 bit
- Parity : None
- Hardware flow control : None

Table 1.1 lists the peripheral functions used and their applications and figure 1.1 presents a block diagram.

Table 1.1 Peripheral Functions Used and Their Applications

Peripheral Function	Application
SCI	Asynchronous serial communication
DTC	Transfers the SCI1 receive data to RAM Transfers the transmit data in RAM to the SCI1
IRQ1	Serial communication start trigger

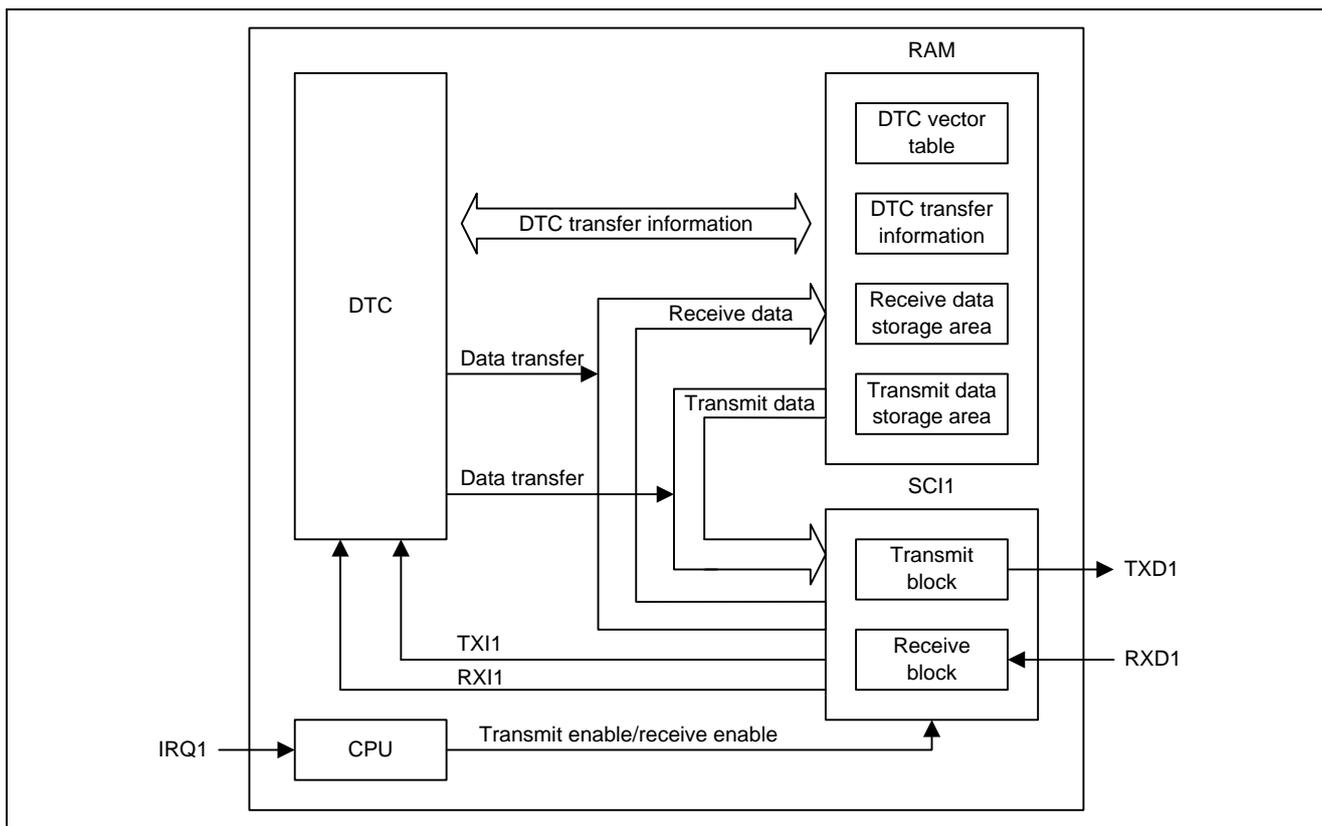


Figure 1.1 Block Diagram

2. Confirmed Operating Condition

The sample code accompanying this application note has been run and confirmed under the conditions below.

(1) For the RX220

Table 2.1 Confirmed Operating Condition

Item	Description
MCU used	R5F52206BDFP (RX220 Group)
Operating frequency	Main clock: 20.0 MHz System clock (ICLK): 20 MHz (1 period of the main clock) Peripheral module clock B (PCLKB): 20 MHz (1 period of the main clock)
Operating voltage	5.0 V: Supplied from the E1 emulator
Integrated development environment	Renesas Electronics Corporation High-performance Embedded Workshop Version 4.09.01.007
C compiler	Renesas Electronics Corporation C/C++ Compiler Package for RX Family V.1.02 Release 01 Compiler option -cpu=rx200 -output=obj="\$(CONFIGDIR)\\$(FILELEAF).obj" -debug -nologo (The integrated development environment default settings are used.)
iodefine.h version	Version 1.0A
Endian order	Little endian
Operating mode	Single-chip mode
Processor mode	Supervisor mode
Sample code version	Version 1.00
Board used	Renesas Starter Kit for RX220 (Product number: R0K505220S000BE)

(2) For the RX21A

Table 2.2 Confirmed Operating Condition

Item	Description
MCU used	R5F521A8BDFP (RX21A Group)
Operating frequency	Main clock: 20.0 MHz PLL: 100 MHz (2 period of the main clock and multiplied by 10) System clock (ICLK): 50 MHz (2 period of the PLL) Peripheral module clock B (PCLKB): 25 MHz (4 period of the PLL)
Operating voltage	3.3 V: Supplied from the E1 emulator
Integrated development environment	Renesas Electronics Corporation High-performance Embedded Workshop Version 4.09.01.007
C compiler	Renesas Electronics Corporation C/C++ Compiler Package for RX Family V.1.02 Release 01 Compiler option -cpu=rx200 -output=obj="\$(CONFIGDIR)\\$(FILELEAF).obj" -debug -nologo (The integrated development environment default settings are used.)
iodefine.h version	Version 1.00
Endian order	Little endian
Operating mode	Single-chip mode
Processor mode	Supervisor mode
Sample code version	Version 1.00
Board used	HSB Series microcontroller board (Hokuto Denshi Co., Ltd.) (Catalog number: HSBRZ21AP-B) Serial connection board <ul style="list-style-type: none"> • RS-232C serial connector (D-sub 9-pin connector) • RS-232C transceiver (MAX3232CPE)

3. Reference Application Notes

For additional information associated with this document, refer to the following application notes.

- RX220 Group Initial Setting Rev.1.00 (R01AN1494EJ0100_RX220)
- RX21A Group Initial Setting Rev.1.00 (R01AN1486EJ0100_RX21A)

The sample code with this application note uses the initialization from the application note noted above. The revision number is the one that was current when this application note was written.

If there is a more recent version, you should replace this code with the most recent version. The most recent version can be downloaded from the Renesas Electronics Corporation web site.

4. Hardware

4.1 Hardware Structure

Figure 4.1 shows a sample RX220 connection and figure 4.2 shows a sample RX21A connection.

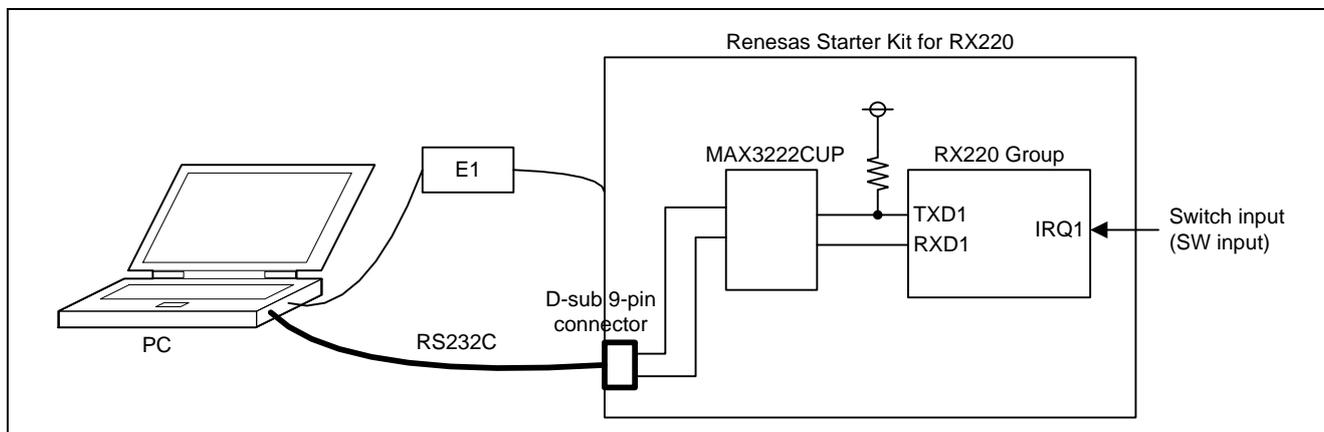


Figure 4.1 Sample RX220 Connection

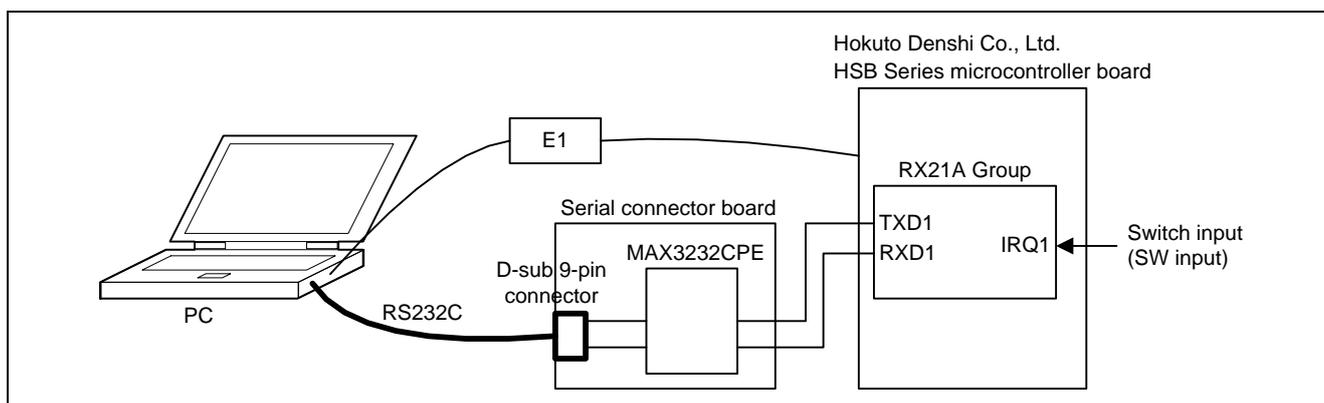


Figure 4.2 Sample RX21A Connection

4.2 Pins Used

Table 4.1 lists the pins used and their functions.

Table 4.1 Pins Used and Their Functions

Pin Name	I/O	Function
P31/IRQ1	Input	Communication start switch input
P15/RXD1	Input	SCI1 receive data input
P16/TXD1	Output	SCI1 transmit data output

5. Software

This sample code automatically processes SCI1 transmit and receive operations by using the DTC module. The communication start switch is pressed SCI1 transmit and receive operations are started.

When transmission is enabled, a TXI1 interrupt request occurs and this acts as the DTC start factor. The data in the transmit data storage area is transferred to the TDR register by the DTC module and transmitted.

When a reception completes, an RXI1 interrupt request occurs and this acts as the DTC start factor. The receive data is transmitted to the receive data storage area by the DTC module.

When 256 transfers of transmit data complete, a TXI1 interrupt request occurs. At this point the TXI1 interrupt is disabled and the TEI1 interrupt is enabled.

When 256 transfers of receive data complete, an RXI1 interrupt occurs. At this point SCI1 reception and the RXI1 interrupt are disabled and the reception complete flag is set to 1.

When the 256-byte transmission has completed, a TEI1 interrupt occurs. At this point SCI1 transmission and the TEI1 interrupt are disabled and the transmission complete flag is set to 1.

The settings for the peripheral functions used are shown below.

SCI1

- Serial communication method : Asynchronous
- Transfer rate : 38400 bps
- Clock source : PCLKB
- Data length : 8 bits
- Stop bits : 1 bit
- Parity function : No parity
- Data transfer method : LSB first
- Interrupts : Reception error interrupt (ERI1) enabled
: Receive data full interrupt (RXI1) enabled
: Transmit data empty interrupt (TXI1) enabled
: Transmit complete interrupt (TEI1) enabled

DTC

- Start factor: TXI1 and RXI1 interrupt requests
- DTC addressing mode: Full addressing mode

[DTC Transfer Settings for Activation by a TXI1 Interrupt Request]

- Transfer mode : Normal transfer mode
- Transfer source addressing mode : SAR register incremented after transfer
- Transfer source address : RAM (transmit data storage area start address)
- Transfer target addressing mode : DAR register holds fixed address
- Transfer target address : SCI1.TDR register
- Data transfer unit : 8 bits
- Transfer count : 256 transfers
- Chained transfers : Disabled
- Interrupts : The CPU is interrupted when the specified data transfer completes.

[DTC Transfer Settings for Activation by a RXI1 Interrupt Request]

—	Transfer mode	:	Normal transfer mode
—	Transfer source addressing mode	:	SAR register holds fixed address
—	Transfer source address	:	SCI1.RDR register
—	Transfer target addressing mode	:	DAR register incremented after transfer
—	Transfer target address	:	RAM (receive data storage area start address)
—	Data transfer unit	:	8 bits
—	Transfer count	:	256 transfers
—	Chained transfers	:	Disabled
—	Interrupts	:	The CPU is interrupted when the specified data transfer completes.

IRQ1 input pin

- Detection method : Falling edge detection
- Digital filter : Disabled
- Interrupt : Not used

5.1 Operation Overview

5.1.1 Transmit Operation

(1) Initialization

After initialization, the sample code waits for a communication start switch input.

(2) Communication start switch input detection

When a communication start switch input is detected, The IRQ1 IR flag is set to 0. When the sample code has verified that transmission and reception have completed by checking the transmission complete and reception complete flags, the transmission complete flag is set to 0 (transmission in progress). The DTC transfer source address and transfer count are set and DTC activation is enabled. The SCI1.SCR.TEIE, TIE, RIE, TE, and RE bits are set to 1 at the same time to enable transmission and reception. The TXI1 interrupt IR flag goes to 1 when the SCI1.SCR.TIE and TE bits are set to 1 at the same time.

(3) Data transfer start

When the TXI1 interrupt is enabled, the TXI1 interrupt IR flag goes to 0 when the DTC is activated. The first byte of the transmit data is transferred from the RAM transmit data storage area to the SCI1.TDR register.

(4) Data transmission start

The TXI1 interrupt IR flag is set to 1 by the transfer of data from the SCI1.TDR register to the SCI1.TSR register and the first byte of transmit data is output from the TXD1 pin. The DTC module is activated by the TXI1 interrupt and the second byte of data is transferred.

(5) TXI1 interrupt

When the 256th data transfer completes, the CPU accepts a TXI1 interrupt request. In TXI1 interrupt handling, the TXI1 interrupt is disabled and the TEI1 interrupt is enabled.

(6) TEI1 interrupt

When the last bit of the 256th byte is transmitted, the SCI1.TDR register is not updated and therefore a TEI1 interrupt request is generated. In TEI1 interrupt handling, transmission is disabled and the TEI1 interrupt is disabled. The transmission complete flag is set to 1 (transmission complete).

After this, this sequence is repeated starting at item (2) above.

Figure 5.1 shows the timing chart for the transmission operation.

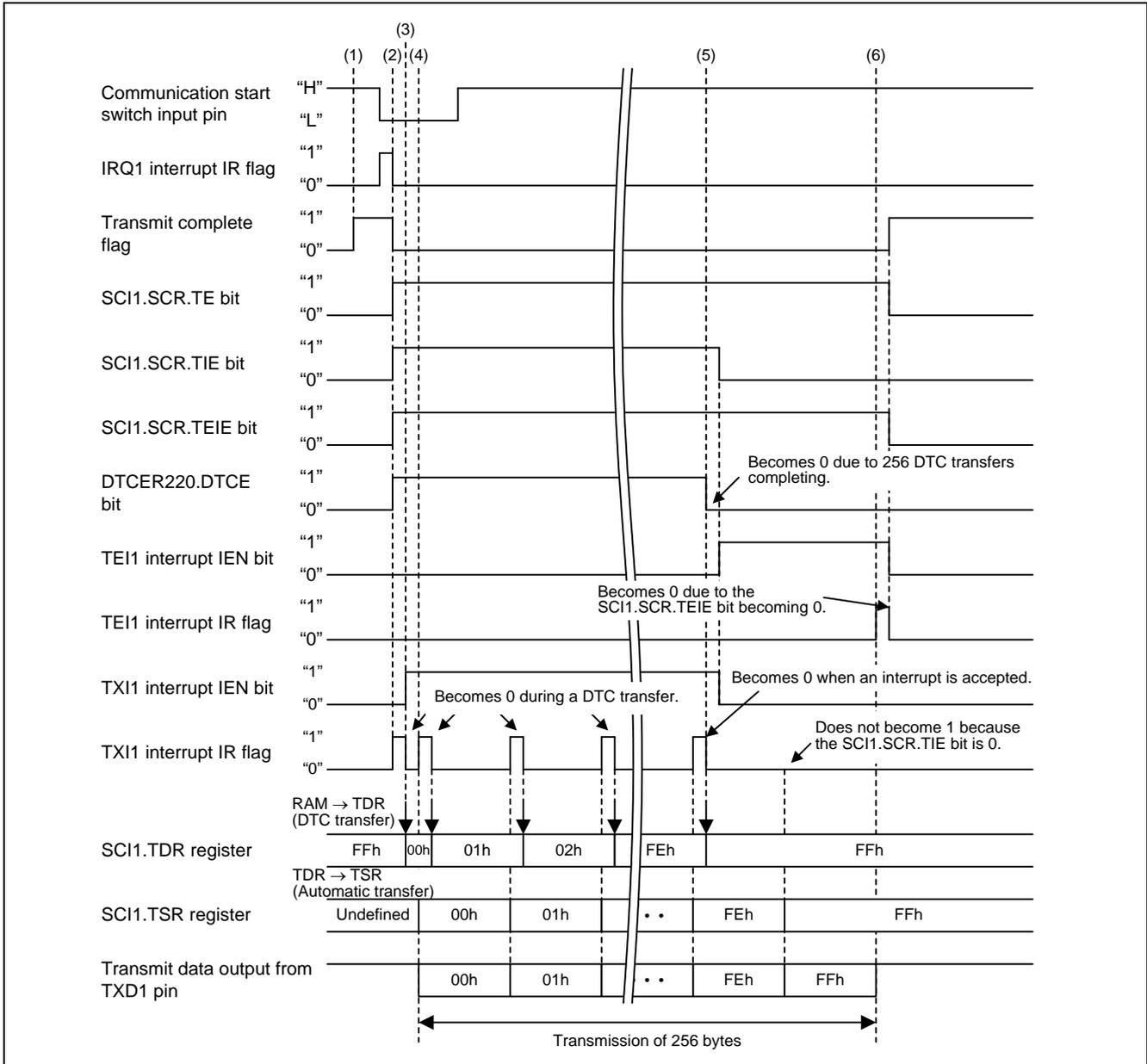


Figure 5.1 Transmission Operation Timing Chart

5.1.2 Receive Operation

(1) Initialization

After initialization, the sample code waits for a communication start switch input.

(2) Communication start switch input detection

When a communication start switch input is detected, The IRQ1 IR flag is set to 1. When the sample code has verified that transmission and reception have completed by checking the transmission complete and reception complete flags, the reception complete flag is set to 1 (reception in progress). The DTC transfer target address and transfer count are set and DTC activation is enabled. The SCI1.SCR.TEIE, TIE, RIE, TE, and RE bits are set to 1 at the same time to enable transmission and reception and the RXI1 interrupt is enabled.

(3) Data reception termination

When the reception of one byte of data completes, the data is transferred from the SCI1.RSR register to the SCI1.RDR register and the RXI1 interrupt IR flag is set to 1.

(4) Data transfer start

The DTC module is started by an RXI1 interrupt request and the RXI1 interrupt IR flag becomes 0. One byte of receive data is transferred from the SCI1.RDR register to the RAM receive data storage area.

(5) RXI1 interrupt

When 256th data transfer completes, the CPU accepts the RXI1 interrupt request. Reception is disabled and the RXI1 interrupt is disabled in RXI1 interrupt handling. The reception complete flag is set to 1 (reception complete). After this, this sequence is repeated starting at item (2) above.

Figure 5.2 shows the timing chart for the reception operation.

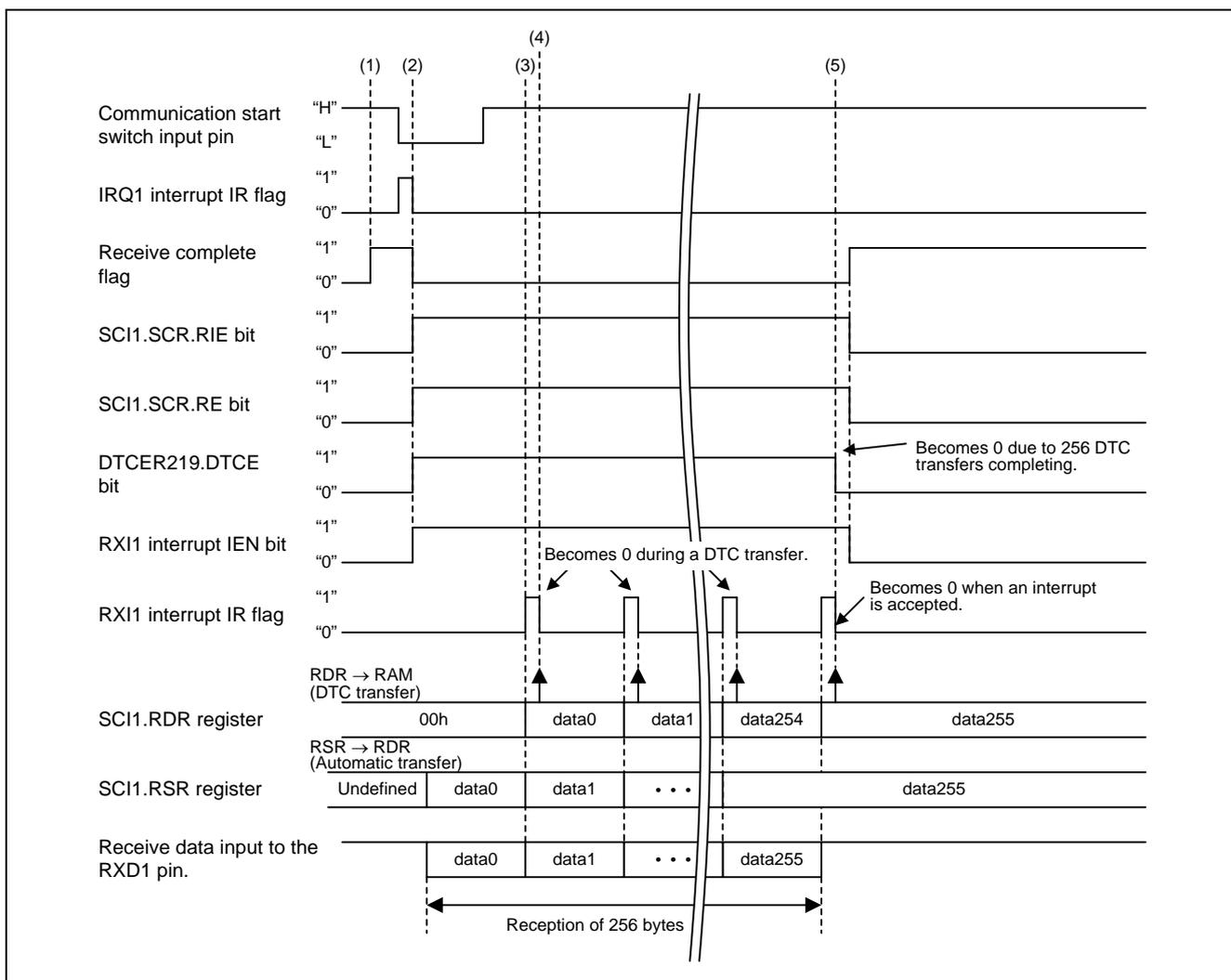


Figure 5.2 Reception Operation Timing Chart

Notes on Embedding in an Actual System

The following phenomenon requires care when using the sample code provided with this application note in an actual system.

- This sample code may not operate correctly if an interrupt used by this application note's code is delayed for an extended period due to, for example, the handling of other interrupts.

5.2 Section Structure

Table 5.1 lists the section information modified in this sample code.

Refer to the latest version of the RX Family C/C++ Compiler Package User's Manual for the methods for adding, modifying, and deleting sections.

Table 5.1 Section Information Modified by this Sample Code

Section Name	Modification	Address	Contents
DTC_SECTION	Added	0000 3000h	DTC vector table

5.3 File Composition

Table 5.2 lists the files used for the sample code. Note that the files generated automatically by the integrated development environment are not shown.

Table 5.2 File Composition

Target Device	File Name	Overview	Remarks
Common	main.c	Main processing	
	device_cfg.h	Device configuration header file	
RX220	r_init_stop_module.c	Stops peripheral functions operating after a reset	
	r_init_stop_module.h	r_init_stop_module.c header file	
	r_init_non_existent_port.c	Nonexistent port initialization	
	r_init_non_existent_port.h	r_init_non_existent_port.c header file	
	r_init_clock.c	Clock initialization	
	r_init_clock.h	r_init_clock.c header file	
RX21A	r_init_stop_module.c	Stops peripheral functions operating after a reset	
	r_init_stop_module.h	r_init_stop_module.c header file	
	r_init_non_existent_port.c	Nonexistent port initialization	
	r_init_non_existent_port.h	r_init_non_existent_port.c header file	
	r_init_clock.c	Clock initialization	
	r_init_clock.h	r_init_clock.c header file	

5.4 Option-Setting Memory

Table 5.3 lists the states of the option settings memory used by the sample code. Set these locations to appropriate values for your user system as required.

Table 5.1 Option Settings Memory Set by the Sample Code

Symbol	Address	Setting Value	Contents
OFS0	FFFF FF8Fh to FFFF FF8Ch	FFFF FFFFh	Stops IWDT after a reset Stops WDT after a reset
OFS1	FFFF FF8Bh to FFFF FF88h	FFFF FFFFh	Disables voltage monitoring resets after a reset Disables HOCOC oscillation after a reset
MDES	FFFF FF83h to FFFF FF80h	FFFF FFFFh	Little endian

5.5 Constants

Table 5.4 lists the constants used in the sample code.

Table 5.4 Constants Used in the Sample Code

Constant	Set value	Description
BUF_SIZE	256	Transmit and receive data storage area size
DTC_CNT	BUF_SIZE	DTC transfer count
SCI_BIT_RATE	15 (When RX220 is selected)	SCI1.BRR register setting value (when PCLKB is 20 MHz)
	19 (When RX21A is selected)	SCI1.BRR register setting value (when PCLKB is 25 MHz)

5.6 Structures and Unions

Figure 5.3 shows the structures and unions used in the sample code.

```
/* **** DTC transfer Information **** */
#pragma bit_order    left          /* Bit field order specification: members are allocated starting with the high order bits. */
#pragma unpack      /* Structure member boundary alignment: alignment is according to the member type. */
struct st_dtc_full_t
{
    union
    {
        uint32_t LONG;
        struct
        {
            uint32_t MRA_MD      :2;
            uint32_t MRA_SZ      :2;
            uint32_t MRA_SM      :2;
            uint32_t             :2;
            uint32_t MRB_CHNE    :1;
            uint32_t MRB_CHNS    :1;
            uint32_t MRB_DISEL   :1;
            uint32_t MRB_DTS     :1;
            uint32_t MRB_DM      :2;
            uint32_t             :2;
            uint32_t             :16;
        } BIT;
    } MR;
    void * SAR;
    void * DAR;
    struct
    {
        uint32_t CRA:16;
        uint32_t CRB:16;
    } CR;
};
#pragma packoption    /* End structure member boundary alignment. */
#pragma bit_order    /* End bit field order specification. */
```

Figure 5.3 Structures and Unions Used in the Sample Code

5.7 Variables

Table 5.5 lists the static variables.

Table 5.5 Static Variables

Type	Name	Description	Function
static uint8_t	trn_end_flag	Transmission complete flag 0: Transmission in progress 1: Transmission complete	main Excep_SCI1_TEI1
static uint8_t	rcv_end_flag	Reception complete flag 0: Reception in progress 1: Reception complete	main Excep_SCI1_RXI1
static uint8_t	trnbuf[BUF_SIZE]	Transmit data storage area	main dtc_init sci1_start
static uint8_t	rcvbuf[BUF_SIZE]	Receive data storage area	dtc_init sci1_start
static struct st_dtc_full_t	dtc_info_rxi1	RXI1 DTC transfer information	dtc_init sci1_start
static struct st_dtc_full_t	dtc_info_txi1	TXI1 DTC transfer information	dtc_init sci1_start
static void *	dtc_vect_table [256]	DTC vector table	dtc_init

5.8 Functions

Table 5.6 shows the functions used in the sample code.

Table 5.6 Functions

Function	Description
main	Main processing
port_init	Port initialization
R_INIT_StopModule	Stops peripheral modules operating after a reset
R_INIT_NonExistentPort	Nonexistent port initialization
R_INIT_Clock	Clock initialization
peripheral_init	Peripheral function initialization
sci1_init	SCI1 initialization
dtc_init	DTC initialization
irq_init	IRQ initialization
sci1_start	Start SCI1 transmission
Excep_SCI1_RXI1	SCI1 receive data full interrupt handler
Excep_SCI1_TXI1	SCI1 transmit data empty interrupt handler
Excep_SCI1_TEI1	SCI1 transmission complete interrupt handler
Excep_SCI1_ERI1	SCI1 receive error interrupt handler

5.9 Function Specifications

This section lists the specifications of the functions in the sample code.

main

Overview	Main processing
Header	None
Declaration	void main(void)
Description	After initialization, starts an SCI1 communication operation when a communication start switch input is detected.
Arguments	None
Return values	None

port_init

Overview	Port initialization
Header	None
Declaration	static void port_init(void)
Description	Initializes the ports.
Arguments	None
Return values	None

R_INIT_StopModule

Overview	Stops peripheral modules operating after a reset
Header	r_init_stop_module.h
Declaration	void R_INIT_StopModule(void)
Description	Performs the settings required to transition to the module stop state.
Arguments	None
Return values	None
Remarks	In this sample code, the transition to the module stop state is not performed. See the "RX220 Group Initialization Example, Revision 1.00" and "RX21A Group Initialization Example, Revision 1.00" application notes for details on this function.

R_INIT_NonExistentPort	
Overview	Nonexistent port initialization
Header	r_init_non_existent_port.h
Declaration	void R_INIT_NonExistentPort(void)
Description	Performs port direction register initialization for non-existent port pins for microcontroller versions that have fewer than 100 pins.
Arguments	None
Return values	None
Remarks	<p>In this sample code, settings for the 100-pin versions (PIN_SIZE = 100) are performed.</p> <p>After this function is called, if an application writes in byte units to a PDR or PODR register that includes ports that do not exist, the application should set the direction control bit to 1 and the port output data storage bit to 0 for those nonexistent ports. See the "RX220 Group Initialization Example, Revision 1.00" and "RX21A Group Initialization Example, Revision 1.00" application notes for details on this function.</p>

R_INIT_Clock	
Overview	Clock initialization
Header	r_init_clock.h
Declaration	void R_INIT_Clock(void)
Description	Initializes the clocks.
Arguments	None
Return values	None
Remarks	<p>In the RX220 sample code, processing in which the main clock is used as the system clock and the subclock is not used is selected.</p> <p>In the RX21A sample code, processing in which the PLL circuit is used as the system clock and the subclock is not used is selected.</p> <p>See the "RX220 Group Initialization Example, Revision 1.00" and "RX21A Group Initialization Example, Revision 1.00" application notes for details on this function.</p>

peripheral_init	
Overview	Peripheral function initialization
Header	None
Declaration	static void peripheral_init(void)
Description	Initializes the used peripheral modules.
Arguments	None
Return values	None

sci1_init	
Overview	SCI1 initialization
Header	None
Declaration	static void sci1_init(void)
Description	Initializes the SCI1 module.
Arguments	None
Return values	None

dtc_init	
Overview	DTC initialization
Header	None
Declaration	static void dtc_init(void)
Description	Initializes the DTC module.
Arguments	None
Return values	None

irq_init	
Overview	IRQ initialization
Header	None
Declaration	static void irq_init(void)
Description	Initializes the IRQ1 module.
Arguments	None
Return values	None

sci1_start	
Overview	Start SCI1 transmission
Header	None
Declaration	static void sci1_start(void)
Description	Starts an SCI1 communication operation
Arguments	None
Return values	None

Excep_SCI1_RXI1	
Overview	SCI1 receive data full interrupt handler
Header	None
Declaration	static void Excep_SCI1_RXI1(void)
Description	Stops reception and disables the RXI1 interrupt. Sets the reception complete flag.
Arguments	None
Return values	None

Excep_SCI1_TXI1	
Overview	SCI1 transmit data empty interrupt handler
Header	None
Declaration	static void Excep_SCI1_TXI1(void)
Description	Disables the TXI1 interrupt and enables the TEI1 interrupt.
Arguments	None
Return values	None

Excep_SCI1_TEI1	
Overview	SCI1 transmission complete interrupt handler
Header	None
Declaration	static void Excep_SCI1_TEI1(void)
Description	Disables transmission and disables the TEI1 interrupt. Sets the transmission complete flag.
Arguments	None
Return values	None

Excep_SCI1_ERI1	
Overview	SCI1 receive error interrupt handler
Header	None
Declaration	static void Excep_SCI1_ERI1(void)
Description	Performs SCI1 reception error handling.
Arguments	None
Return values	None
Remarks	In this sample code, SCI1 reception errors are not handled. (The code goes into an infinite loop.) If required, add the appropriate processing to this function.

5.10 Flowcharts

5.10.1 Main Processing

Figure 5.4 shows the flowchart for the main processing.

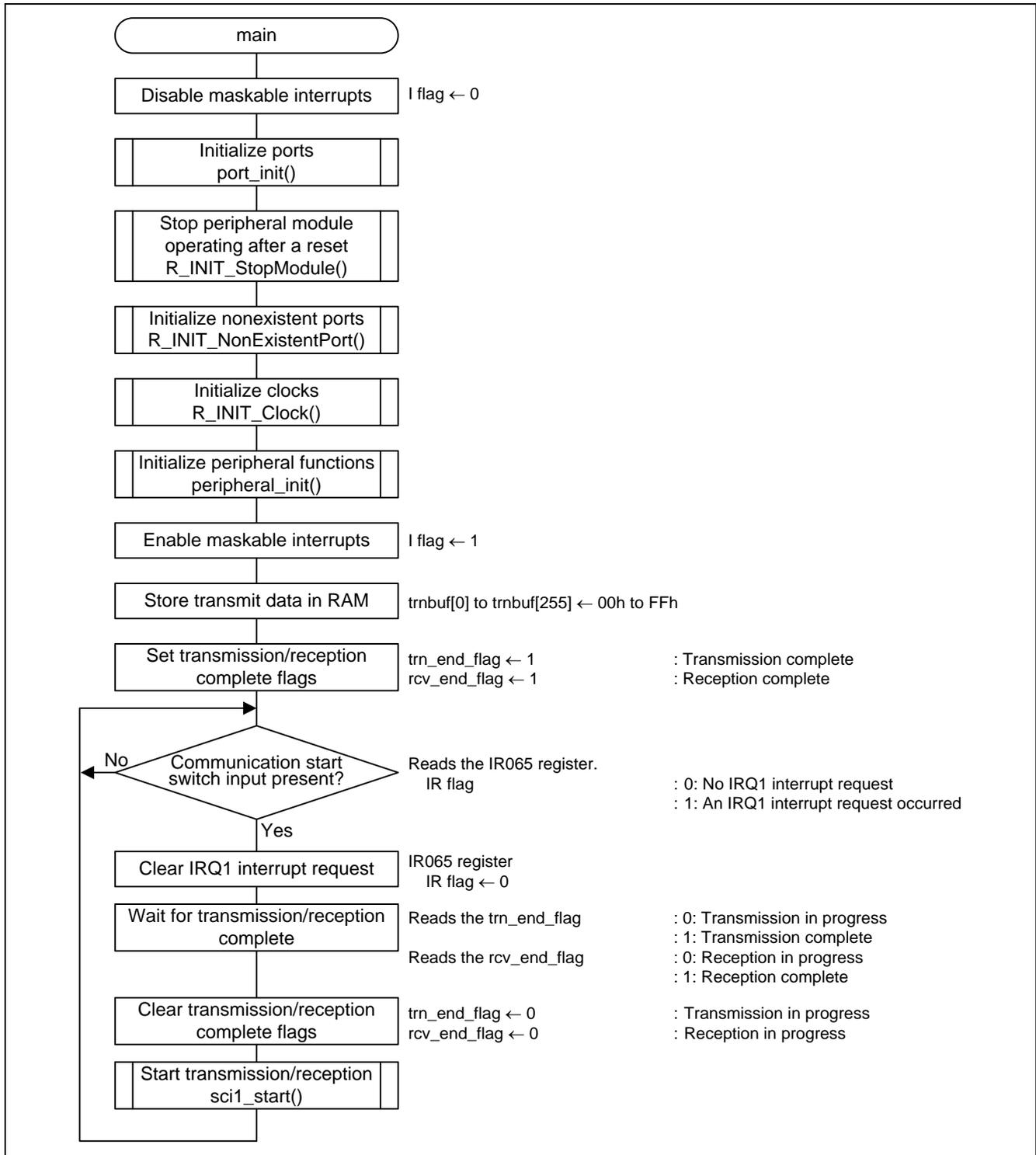


Figure 5.4 Main Processing

5.10.2 Port Initialization

Figure 5.5 shows the flowchart for port initialization.

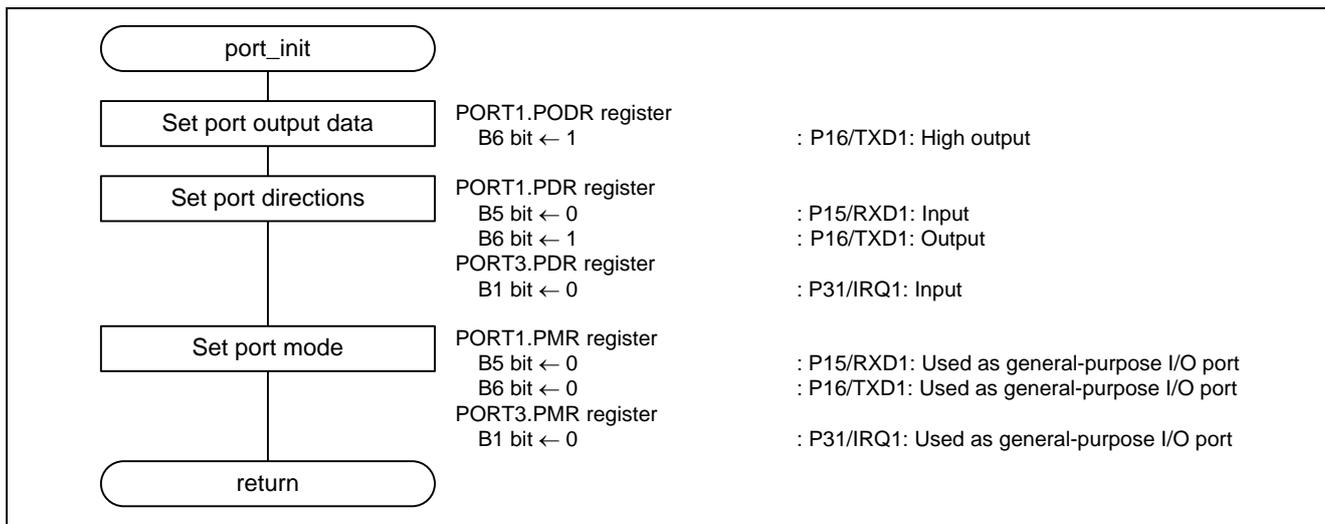


Figure 5.5 Port Initialization

5.10.3 Peripheral Function Initialization

Figure 5.6 shows the flowchart for peripheral function initialization.

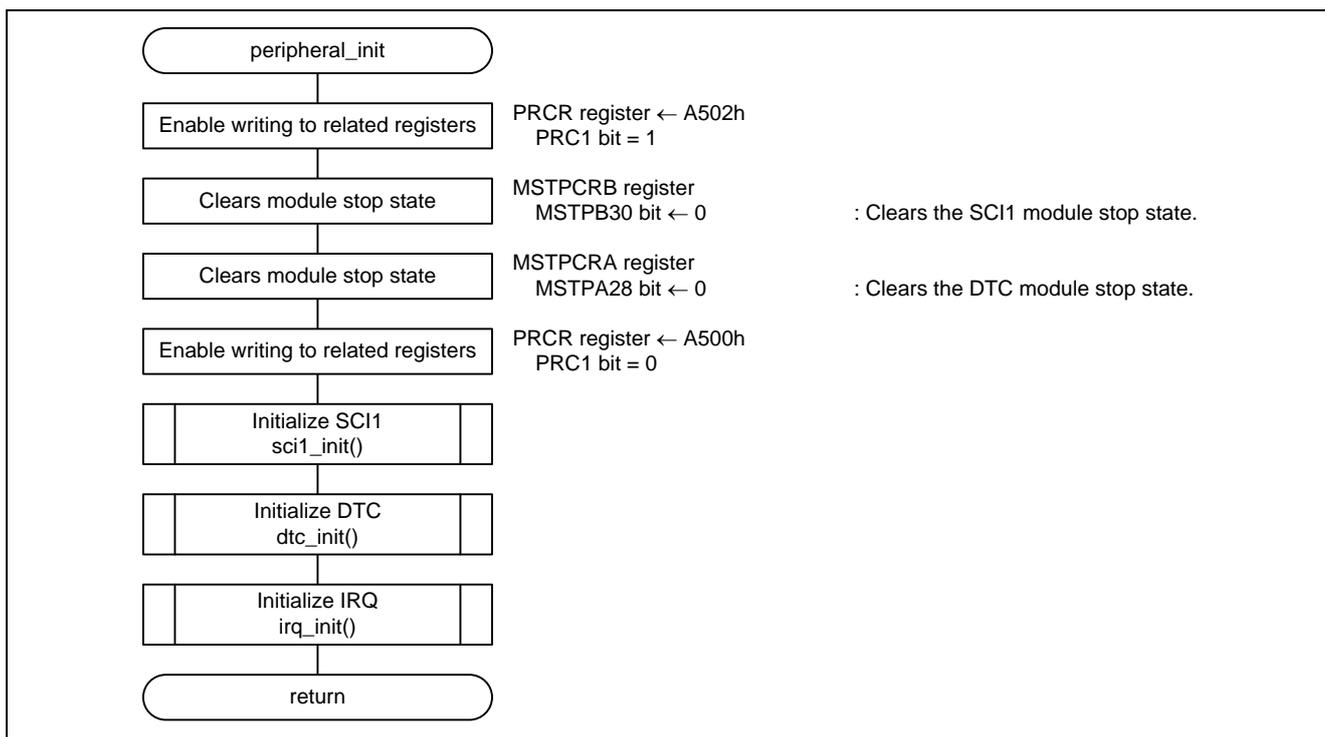


Figure 5.6 Peripheral Function Initialization

5.10.4 SCI1 Initialization

Figure 5.7 shows the flowchart for SCI1 initialization.

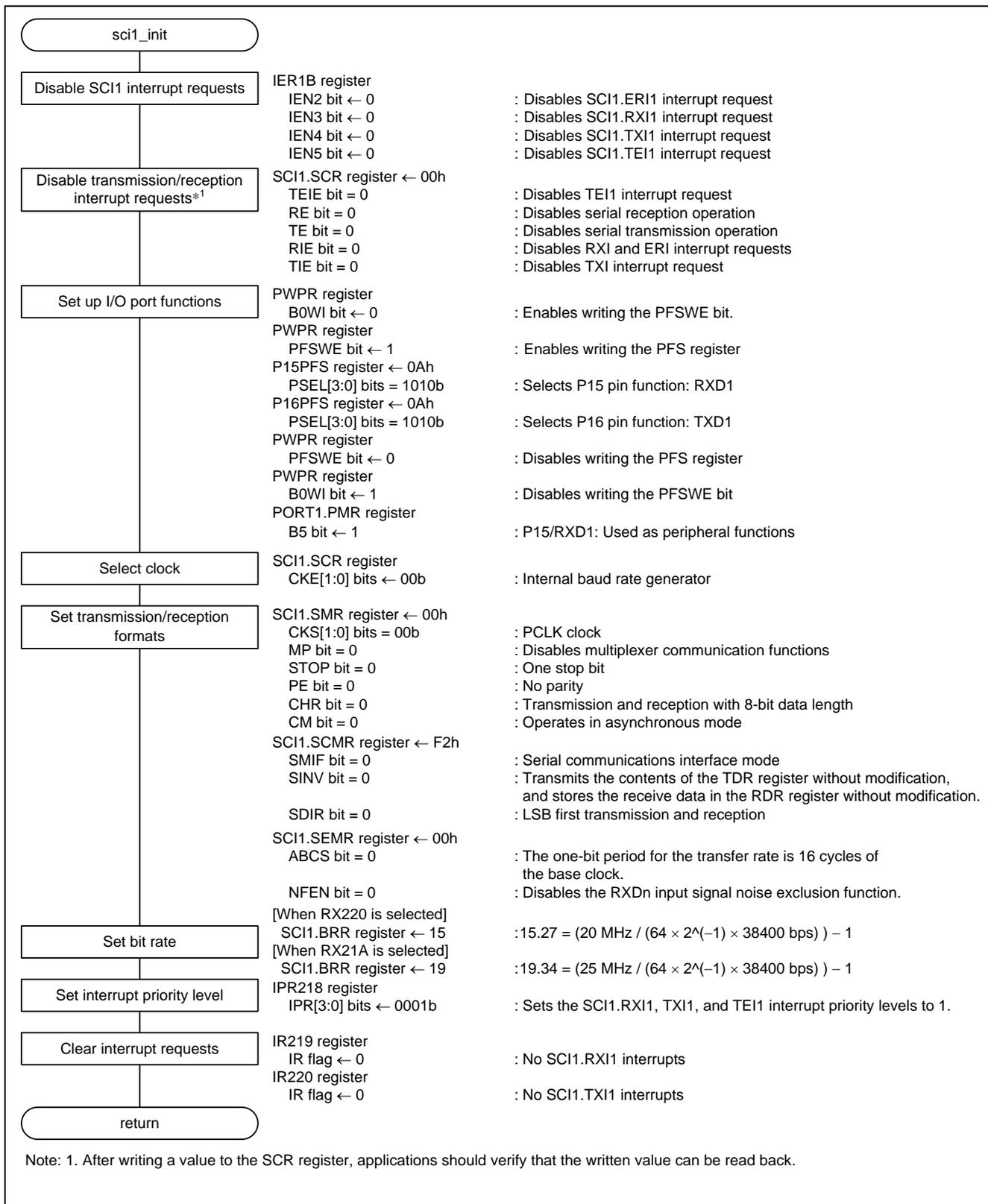


Figure 5.7 SCI1 Initialization

5.10.5 DTC Initialization

Figure 5.8 shows the flowchart for DTC initialization.

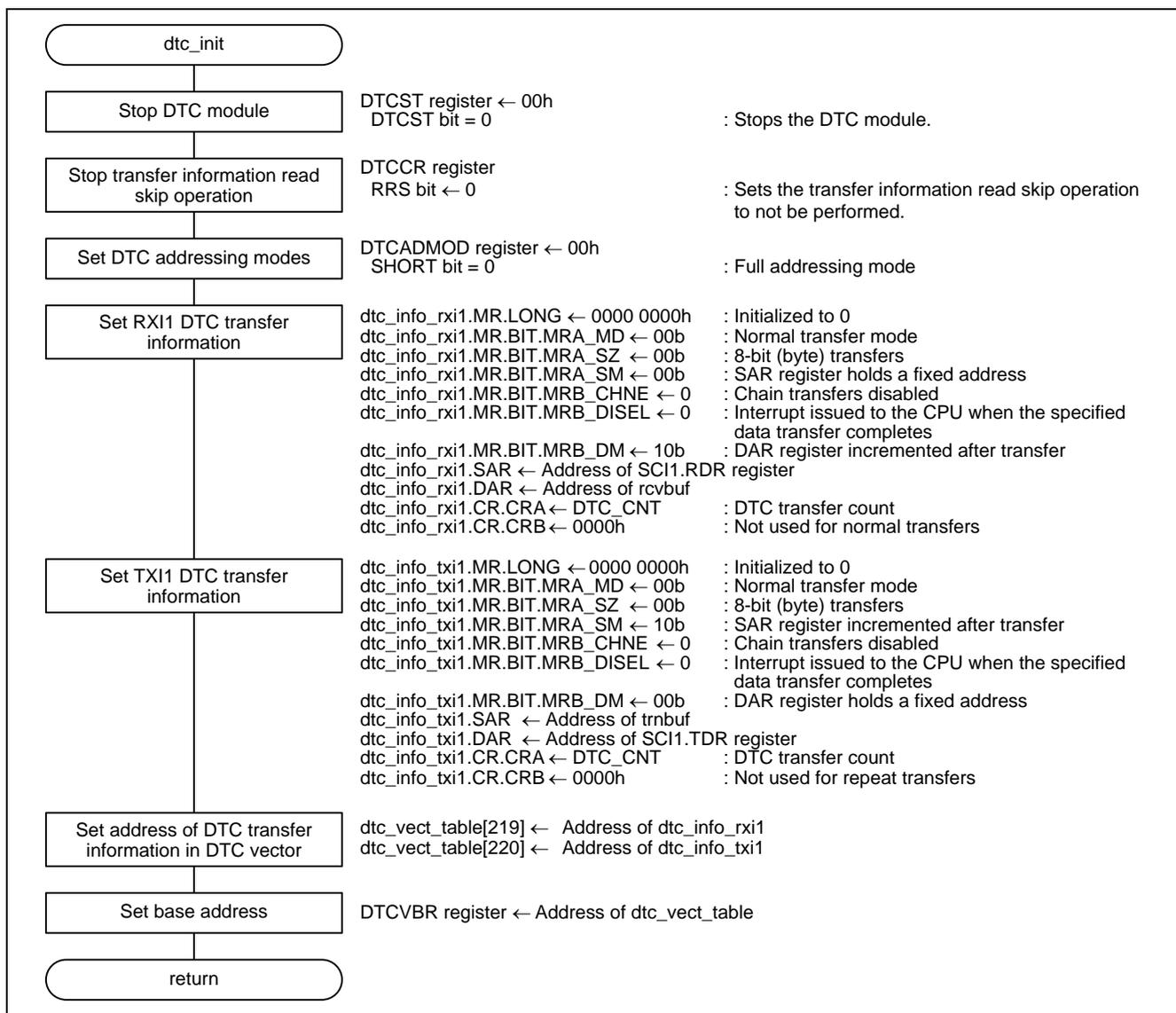


Figure 5.8 DTC Initialization

5.10.6 IRQ Initialization

Figure 5.9 shows the flowchart for IRQ initialization.

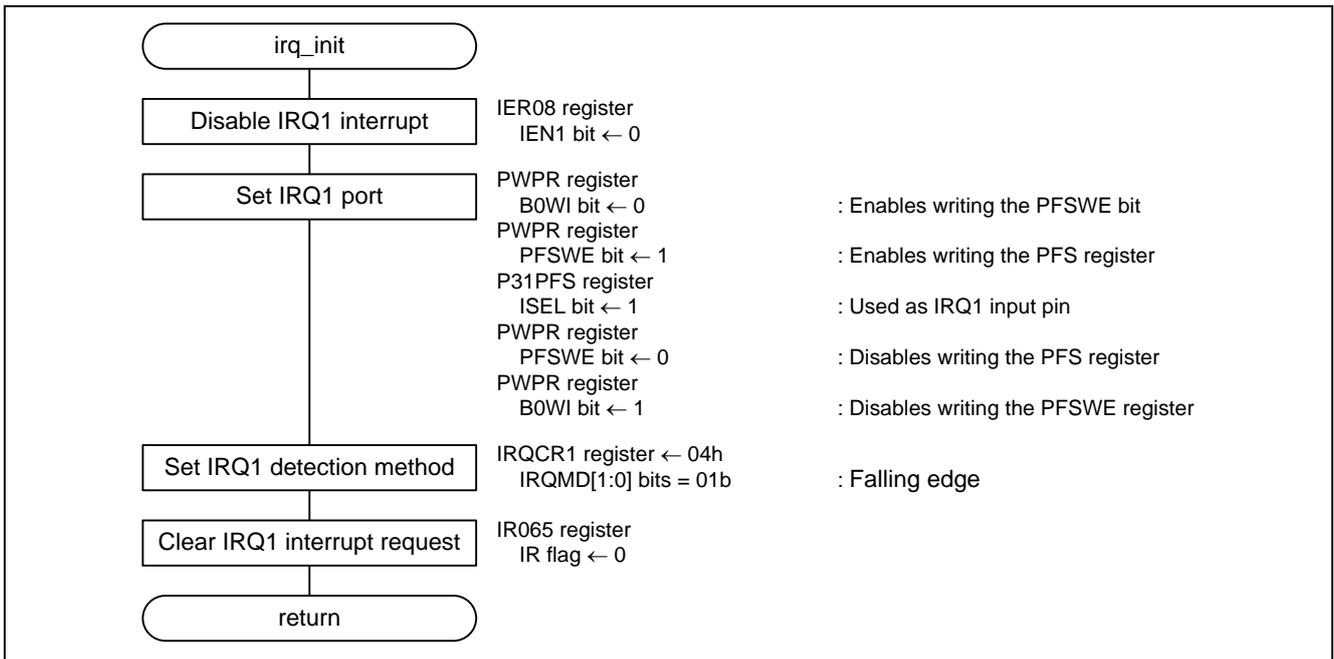


Figure 5.9 IRQ Initialization

5.10.7 Start SCI1 Communication

Figure 5.10 shows the flowchart for starting SCI1 communication.

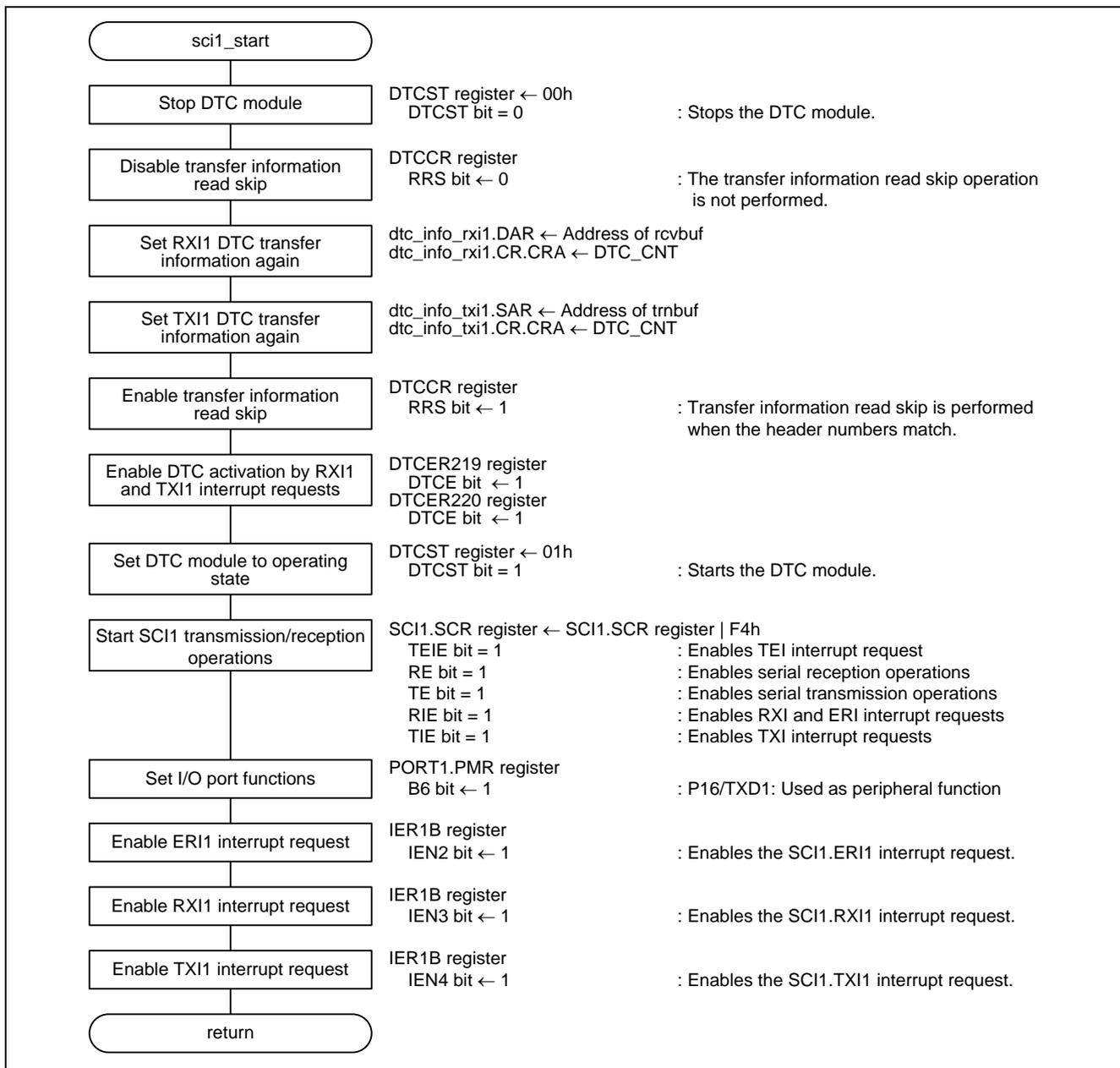


Figure 5.10 Start SCI1 Communication

5.10.8 SCI1 Receive Data Full Interrupt Handler

Figure 5.11 shows the flowchart for SCI1 receive data full interrupt handling.

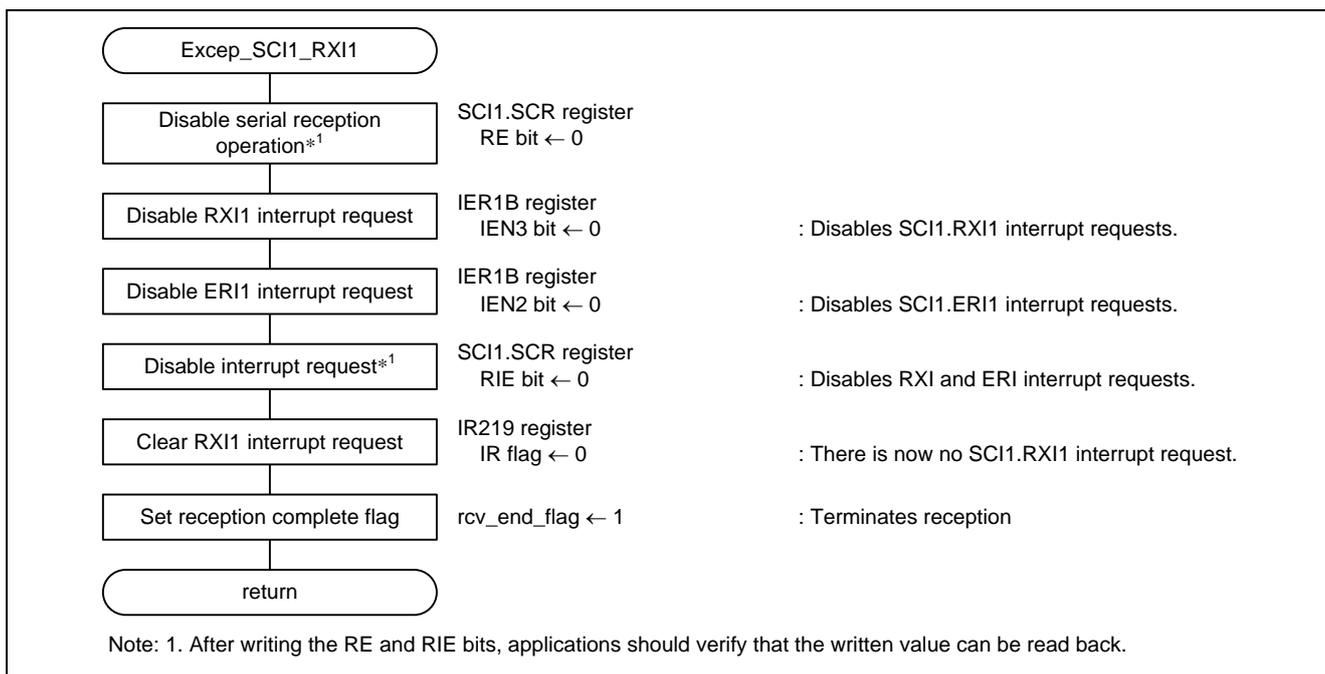


Figure 5.11 SCI1 Receive Data Full Interrupt Handler

5.10.9 SCI1 Transmit Data Empty Interrupt Handler

Figure 5.12 shows the flowchart for SCI1 transmit data empty interrupt handling.

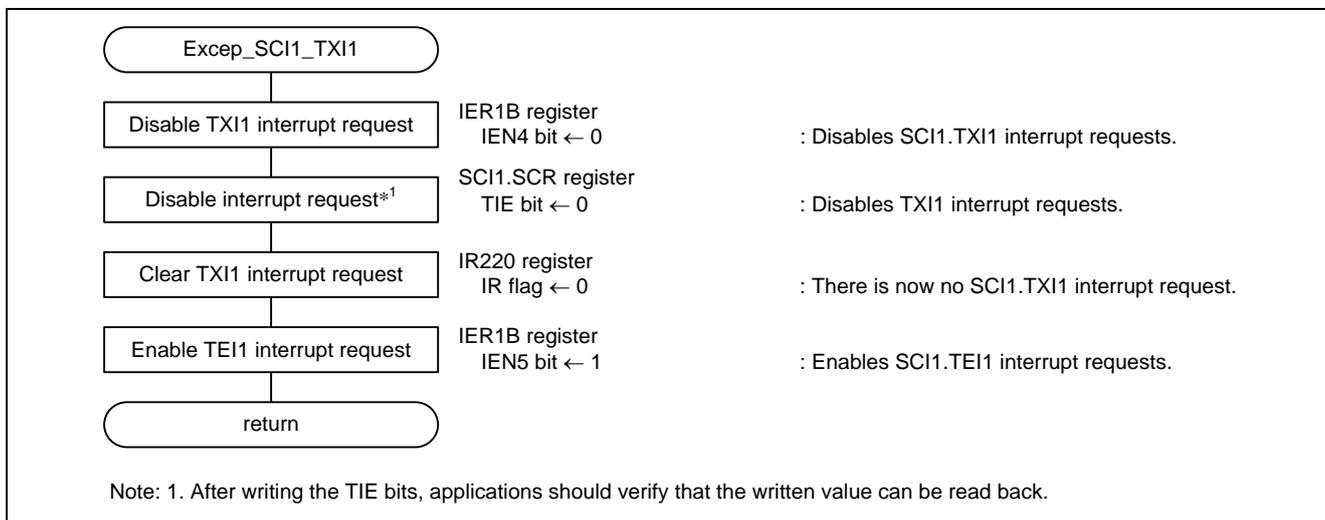


Figure 5.12 SCI1 Transmit Data Empty Interrupt Handler

5.10.10 SCI1 Transmission Complete Interrupt Handler

Figure 5.13 shows the flowchart for SCI1 transmission complete interrupt handling.

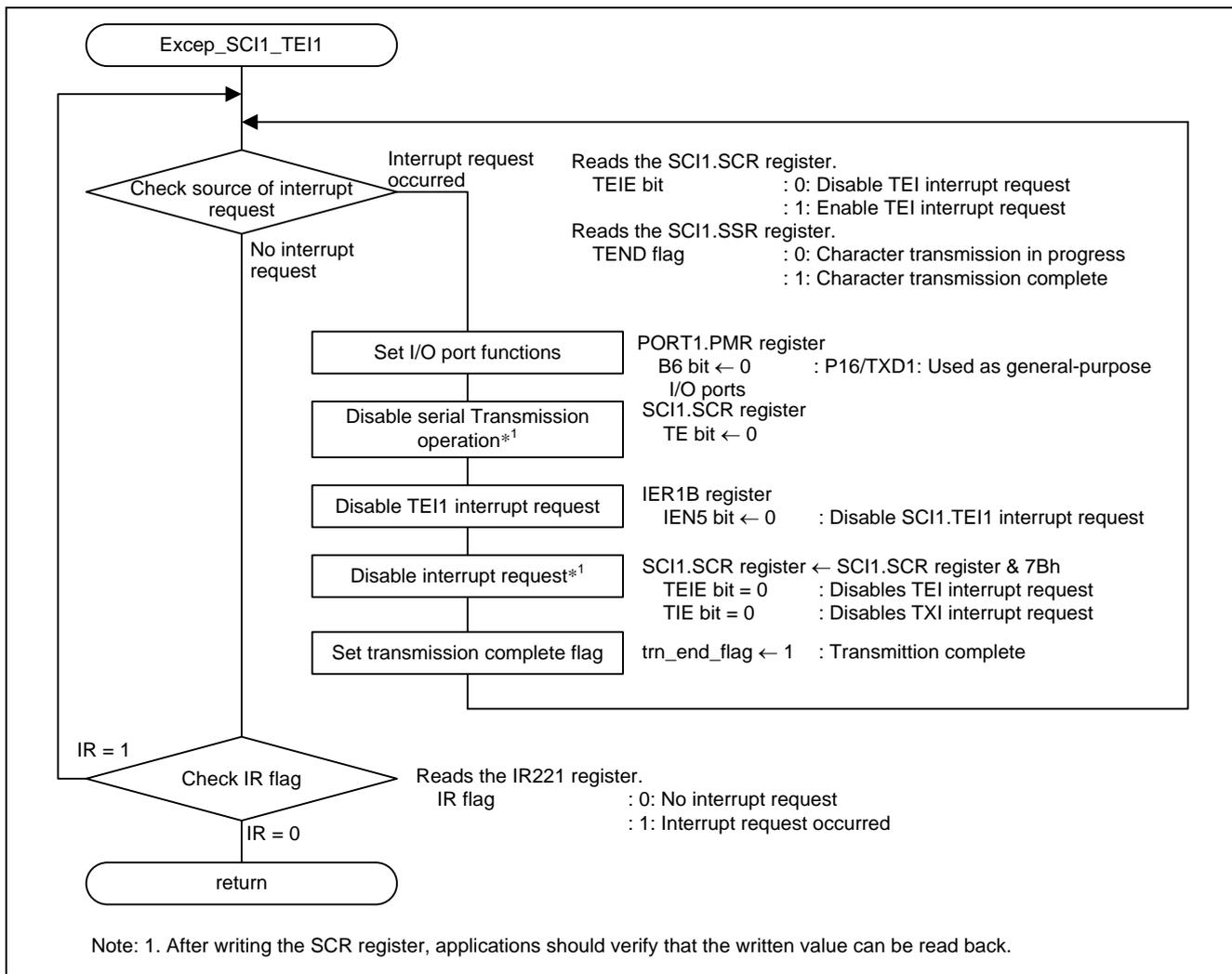


Figure 5.13 SCI1 Transmission Complete Interrupt Handler

5.10.11 SCI1 Reception Error Interrupt Handler

Figure 5.14 shows the flowchart for SCI1 reception error interrupt handling.

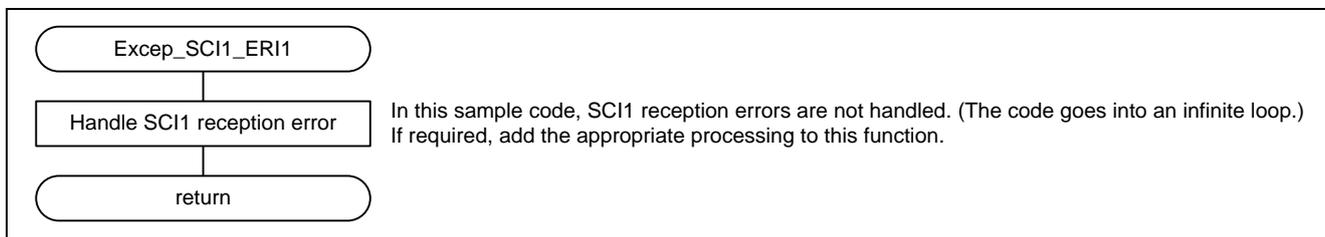


Figure 5.14 SCI1 Reception Error Interrupt Handler

6. Sample Code

The sample code can be downloaded from the Renesas Electronics Corporation web site.

7. Usage Notes

7.1 Sample Code Usage Notes

Either an RX220 Group or an RX21A Group device can be selected in the sample code. Use the following settings when selecting the device.

1. In the project tab in the workspace window in the High-performance Embedded Workshop, set the project for the device to be used to be the active project.
Refer to the latest version of the High-performance Embedded Workshop user's manual for the procedure for setting the active project.

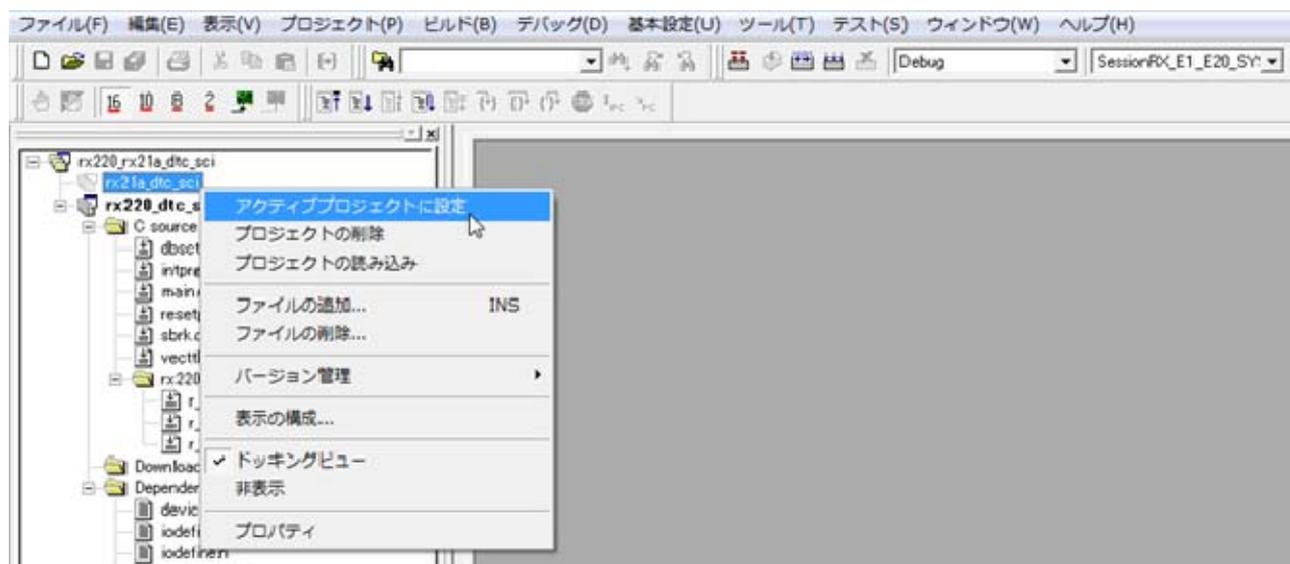


Figure 7.1 Setting the Active Project

2. Select the device used in the device configuration file (device_cfg.h). Uncomment the code for the device used and comment out the codes for unused devices.

7.2 Board Usage Notes

Keep the following points in mind when verifying the operation of the sample code for the board used as stipulated in this application note.

- Board used: Renesas Starter Kit for RX220 (R0K505220S000BE)
Although the microcontroller ports P20 and P21 are connected to the RS-232C serial connector through the RS-232C transceiver when the Renesas Starter Kit for RX220 is shipped from the factory, since ports P20 and P21 do not have an SCI function, these connections must be changed to P15/RXD1 and P16/TXD1.
- Board used: Hokuto Denshi Co., Ltd. HSB Series Microcontroller Board (Catalog number: HSBRX21AP-B)
No RS-232C transceiver or RS-232C serial connector are connected in the Hokuto Denshi Co., Ltd. HSB Series Microcontroller Board. To verify operation, the user must provide an RS-232C transceiver and an RS-232C serial connector.

8. Reference Documents

User's Manual: Hardware

RX220 Group User's Manual: Hardware Rev.1.00 (R01UH0292EJ)

RX21A Group User's Manual: Hardware Rev.1.00 (R01UH0251EJ)

The latest version can be downloaded from the Renesas Electronics website.

User's Manual: Development Tools

RX Family C/C++ Compiler Package V.1.01 User's Manual Rev.1.00 (R20UT0570EJ)

The latest version can be downloaded from the Renesas Electronics website.

High-performance Embedded Workshop V.4.09 User's Manual Rev.1.00 (R20UT0372EJ)

The latest version can be downloaded from the Renesas Electronics website.

Technical Update / Technical News

The latest information can be downloaded from the Renesas Electronics website.

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Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Feb 14, 2014	—	First edition issued

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable.

When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different type number, confirm that the change will not lead to problems.

- The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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